

3/25/97 STAFF

AL NEEDS TO CONDUCE A REVIEW SESSION FOR THE
S:ARC SORT & ASSP TEST CHIP.

SIT DOWN W/ BEHROOZ TO WORK OUT W.P. REVIEW
PROCESS FOR BGA CLB.

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PAGE 1

VOL JET

BGA PACKAGE BROKEN TRACES

NEED TO FOCUS ON REDUCING RISK O
PART DAMAGE

IMPROVED TRAY DESIGN

IMPROVED PACKAGE DESIGN

BETTER CORNER SUPPORT

EXTEND MOLD COMPOUND INTO PLG CORNERS
THICKER SUBSTRATES.

HT WILL INVESTIGATE.

PACKAGE LONGEVITY

HT REVIEW ANAM CORRECTIVE ACTION

ANAM Cpk VARY NEARLY 2 AGAIN FOR LAST WEEK,
FROM 1.4.

PAGE 4

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4/1/97

MIA START UP MEETING

492 CERTIFICATION SIMMETER SCHEDULE FICO

SAMSUNG - CURRENTLY SHIPPING 50K/WEEK
CALL NEEDS T3 DATA ON THESE LOTS TO LIFT
THE 50K/WEEK RESTRICTION.

SIMMETER - BY SATS SCHEDULE ALREADY PUBLISHED
W.P. WILL AFFECT BOTH HELL & ANAM
DATA FROM BOTH SUB LOTS TO BE INCLUDED
IN W.P.

SH IS CONCERNED ABOUT SUBSTRATE CRACKING ON
THE 492 WHEN CONTACTOR FORCE IS INCREASED
TO 100 lbs 40 lb ORIGINAL FORCE (15Ks)
(40Ks)

KS WONG MAY NEED TO GENERATE THE W.P.

492 COMPLAINTS

CALL PUBLISHED 6 LOTS WORTH OF DATA
LAST WEDNESDAY. CHECK ON THIS AND REVIEW.

CALL IS WORKING WITH HT TO FINALIZE THE FICO
WASTE PAPER.